ASSOCIATION CONNECTING LECTRONICS INDUSTRIES*				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
			Form Type Distribute						on				
Supplier Information													
Company name* Comp			Company unique ID			Unique ID Authority				Response Date*			
onsemi										2025-05-10			
Contact Name Title - Contact			ct	Phor		Phone - Contact*			Email -	Email - Contact*			
Product-Env-Stewards Product Envi			nviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repre			resentative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Pro			Product Enviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	DTA115	DTA115EET1G SS SC75 BR XS7		R PNP 50V		2025-05-10 CN1		CN1		2.51	mg	Each	
Manufacturing Proccess Informa	tion												
Terminal Plating / Grid Array M	ninal Plating / Grid Array Material Terminal Base All		Alloy J	-STD-020 MSL	Rating	Peak Proce	s Body Tempe	ature Max Time at Peal	k Tempera	ture Numb	er of Reflow Cyd	eles	
Matte Tin (Sn) - annealed CU Alloy]	l		260	С	30	seco	nds 3				
Comments													
evel 1 - maximum time at peak temperat	ure during sol	Idering is 10-3	0 seconds										
for more information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-	_		-
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.06	mg	Supplier	Silicon (Si)	7440-21-3		0.06	mg
Lead Frame	0.75	mg	В	Nickel (Ni)	7440-02-0		0.2843	mg
			Supplier	Iron (Fe)	7439-89-6		0.393	mg
			Supplier	Copper (Cu)	7440-50-8		0.0727	mg
Mold Compound-Black	1.57	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.157	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0078	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2277	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.0205	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.157	mg
Plating	0.12	mg	Supplier	Tin (Sn)	7440-31-5		0.12	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg